

## 600V Trench and Fieldstop IGBT

| PRODUCT SUMMARY   |                               |                               |
|-------------------|-------------------------------|-------------------------------|
| $V_{CE}$ (V)      | 600                           |                               |
| $I_C$ (A)         | 14 ( $T_C=25^\circ\text{C}$ ) | 7 ( $T_C=100^\circ\text{C}$ ) |
| $V_{CE(sat)}$ (V) | 1.6                           |                               |
| $I_{CM}$ (A)      | 21                            |                               |

### FEATURES

- Very Low  $V_{CEsat}$
- Low turn-off losses
- High speed switching
- Maximum junction temperature  $175^\circ\text{C}$
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)



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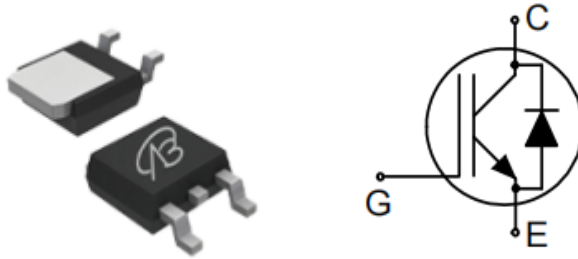
### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
  - Battery chargers
- Renewable energy
  - Solar (PV inverters)
- Switch mode power supplies (SMPS)

### Package pin definition

- Pin1 G - Gate
- Pin2 C & backside - Collector
- Pin3 E - Emitter

TO-252



Top View

| ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted) |                                               |                         |                                   |             |      |
|---------------------------------------------------------------------------|-----------------------------------------------|-------------------------|-----------------------------------|-------------|------|
| PARAMETER                                                                 |                                               |                         | SYMBOL                            | LIMIT       | UNIT |
| Collector-Emitter Voltage                                                 |                                               |                         | V <sub>CE</sub>                   | 600         | V    |
| Gate-Emitter Voltage                                                      |                                               |                         | V <sub>GE</sub>                   | ±30         |      |
| Continuous Collector Current (T <sub>J</sub> = 150 °C)                    | V <sub>GE</sub> at 15 V                       | T <sub>C</sub> = 25 °C  | I <sub>C</sub>                    | 14          | A    |
|                                                                           |                                               | T <sub>C</sub> = 100 °C |                                   | 7           |      |
| Pulsed Collector Current <sup>a</sup>                                     |                                               |                         | I <sub>CM</sub>                   | 21          |      |
| Diode Forward Current <sup>b</sup>                                        |                                               |                         | I <sub>F</sub>                    | 7           | A    |
| Maximum Power Dissipation                                                 |                                               | T <sub>C</sub> = 25 °C  | P <sub>D</sub>                    | 55          | W    |
|                                                                           |                                               | T <sub>C</sub> = 100 °C |                                   | 43          | W    |
| Operating Junction and Storage Temperature Range                          |                                               |                         | T <sub>J</sub> , T <sub>stg</sub> | -55 to +175 | °C   |
| Short Circuit Withstand Time <sup>TC=150°C</sup>                          | V <sub>GE</sub> = 15V, V <sub>CE</sub> ≤ 400V |                         | t <sub>sc</sub>                   | 3           | μs   |
| Short Circuit Withstand Time <sup>TC=100°C</sup>                          | V <sub>GE</sub> = 15V, V <sub>CE</sub> ≤ 330V |                         |                                   | 5           |      |
| Soldering Recommendations (Peak Temperature) <sup>c</sup>                 |                                               | for 10 s                |                                   | 260         | °C   |

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- Current limited by maximum junction temperature.
- 1.6 mm from case.

**THERMAL RESISTANCE RATINGS**

| PARAMETER                   | SYMBOL     | TYP. | MAX. | UNIT |
|-----------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient | $R_{thJA}$ | -    | 40   | °C/W |
| Maximum Junction-to-Case    | $R_{thJC}$ | -    | 1.5  |      |

**SPECIFICATIONS** ( $T_J = 25\text{ °C}$ , unless otherwise noted)

| PARAMETER                                 | SYMBOL        | TEST CONDITIONS                                                                                                          |                                              | MIN.       | TYP.   | MAX.   | UNIT          |
|-------------------------------------------|---------------|--------------------------------------------------------------------------------------------------------------------------|----------------------------------------------|------------|--------|--------|---------------|
| Static                                    |               |                                                                                                                          |                                              |            |        |        |               |
| Collector-Emitter Breakdown Voltage       | $BV_{CE}$     | $V_{GE} = 0\text{ V}$ , $I_C = 250\text{ }\mu\text{A}$<br>$V_{GE} = 0\text{ V}$ , $I_C = 1\text{ mA}$                    |                                              | 600<br>600 | -<br>- | -<br>- | V             |
| Gate-Source Threshold Voltage (N)         | $V_{GE(th)}$  | $V_{CE} = V_{GE}$ , $I_D = 250\text{ }\mu\text{A}$                                                                       |                                              | 4          | 5      | 6      | V             |
| Zero Gate Voltage Collector Current       | $I_{CES}$     | $V_{CE} = 600\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_J = 25\text{ }^{\circ}\text{C}$                                     |                                              | -          | 1      | 20     | $\mu\text{A}$ |
|                                           |               | $V_{CE} = 600\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$                                    |                                              | -          | 1000   | -      | $\mu\text{A}$ |
| Gate-Emitter Leakage Current              | $I_{GES}$     | $V_{CE} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$                                                                       |                                              | -          | -      | 100    | nA            |
| Collector-Emitter Saturation Voltage      | $V_{CE(sat)}$ | $V_{GE} = 15\text{ V}$                                                                                                   | $I_C = 7\text{ A}$                           | -          | 1.7    | 2.1    | V             |
| Forward Transconductance                  | $g_{fs}$      | $V_{CE} = 20\text{ V}$ , $I_C = 7\text{ A}$                                                                              |                                              | -          | 40     | -      | S             |
| Dynamic                                   |               |                                                                                                                          |                                              |            |        |        |               |
| Input Capacitance                         | $C_{ies}$     | $V_{GE} = 0\text{ V}$ , $V_{CE} = 25\text{ V}$ ,<br>$f = 500\text{ KHz}$                                                 |                                              | -          | 1400   | -      | pF            |
| Output Capacitance                        | $C_{oes}$     |                                                                                                                          |                                              | -          | 76     | -      |               |
| Reverse Transfer Capacitance              | $C_{res}$     |                                                                                                                          |                                              | -          | 21     | -      |               |
| Turn-on Energy                            | $E_{on}$      | $V_{CE} = 400\text{ V}$ , $V_{GE} = 0/15\text{V}$ ,<br>$I_C = 7\text{ A}$ , $R_g = 10\Omega$                             |                                              | -          | 0.81   | -      | nJ            |
| Turn-off Energy                           | $E_{off}$     |                                                                                                                          |                                              | -          | 0.26   | -      |               |
| Total Gate Charge                         | $Q_g$         | $V_{GE} = 15\text{ V}$                                                                                                   | $I_C = 7\text{ A}$ , $V_{CE} = 400\text{ V}$ | -          | 18     | -      | nC            |
| Gate-Emitter Charge                       | $Q_{ge}$      |                                                                                                                          |                                              | -          | 15     | -      |               |
| Gate to Collector Charge                  | $Q_{gc}$      |                                                                                                                          |                                              | -          | 33     | -      |               |
| Turn-On Delay Time                        | $t_{d(on)}$   | $V_{CE} = 400\text{ V}$ , $V_{GE} = 0/15\text{V}$ ,<br>$I_C = 7\text{ A}$ , $R_g = 10\Omega$                             |                                              | -          | 45     | -      | ns            |
| Rise Time                                 | $t_r$         |                                                                                                                          |                                              | -          | 25     | -      |               |
| Turn-Off Delay Time                       | $t_{d(off)}$  |                                                                                                                          |                                              | -          | 115    | -      |               |
| Fall Time                                 | $t_f$         |                                                                                                                          |                                              | -          | 24     | -      |               |
| Internal emitter inductance measured 5 mm | $L_E$         |                                                                                                                          |                                              | -          | 13     | -      | nH            |
| Diode Characteristics                     |               |                                                                                                                          |                                              |            |        |        |               |
| Diode Forward Current                     | $I_F$         | IGBT symbol showing the<br>integral reverse junction diode                                                               |                                              | -          | -      | 7      | A             |
| Pulsed Diode Forward Current              | $I_{FM}$      |                                                                                                                          |                                              | -          | -      | 21     |               |
| Diode Forward Voltage                     | $V_F$         | $I_F = 7\text{ A}$                                                                                                       |                                              | -          | 1.75   | 2.0    | V             |
| Reverse Recovery Time                     | $t_{rr}$      | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_F = 7\text{ A}$ ,<br>$di_F/dt = 200\text{ A}/\mu\text{s}$ , $V_R = 400\text{ V}$ |                                              | -          | 70     | -      | ns            |
| Reverse Recovery Charge                   | $Q_{rr}$      |                                                                                                                          |                                              | -          | 0.26   | -      | $\mu\text{C}$ |
| Reverse Recovery Current                  | $I_{RRM}$     |                                                                                                                          |                                              | -          | 9      | -      | A             |

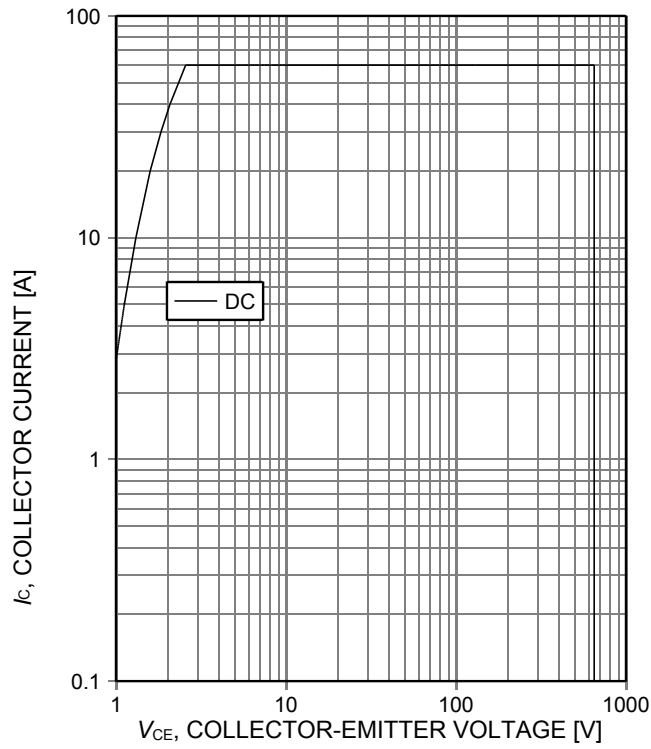


Figure 1. **Forward bias safe operating area**  
 ( $D=0$ ,  $T_C=25^\circ\text{C}$ ,  $T_{vj}\leq 175^\circ\text{C}$ ;  $V_{GE}=15\text{V}$ .  
 Recommended use at  $V_{GE}\geq 7.5\text{V}$ )

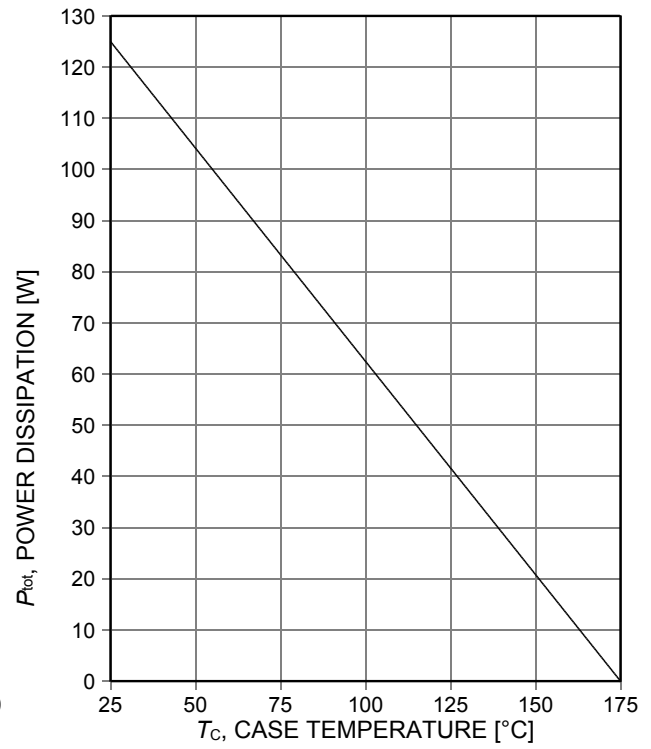


Figure 2. **Power dissipation as a function of case temperature**  
 ( $T_{vj}\leq 175^\circ\text{C}$ )

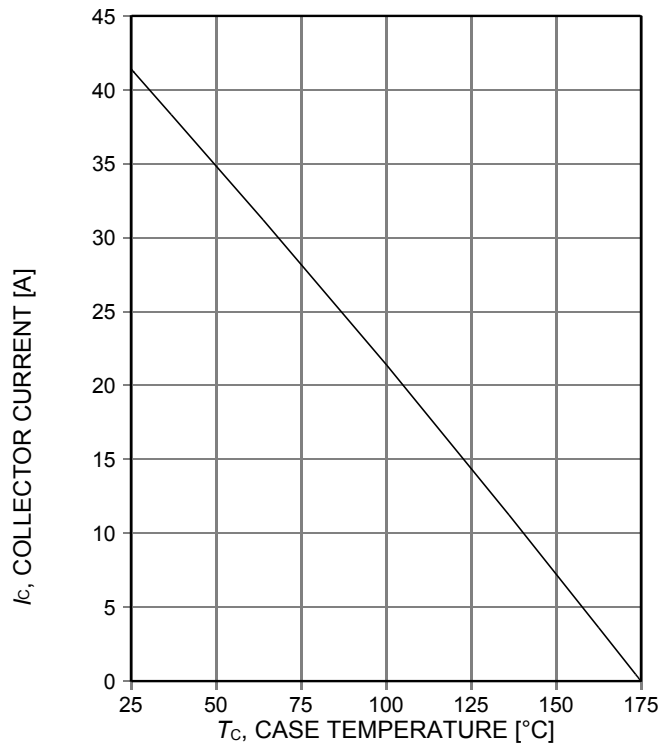


Figure 3. **Collector current as a function of case temperature**

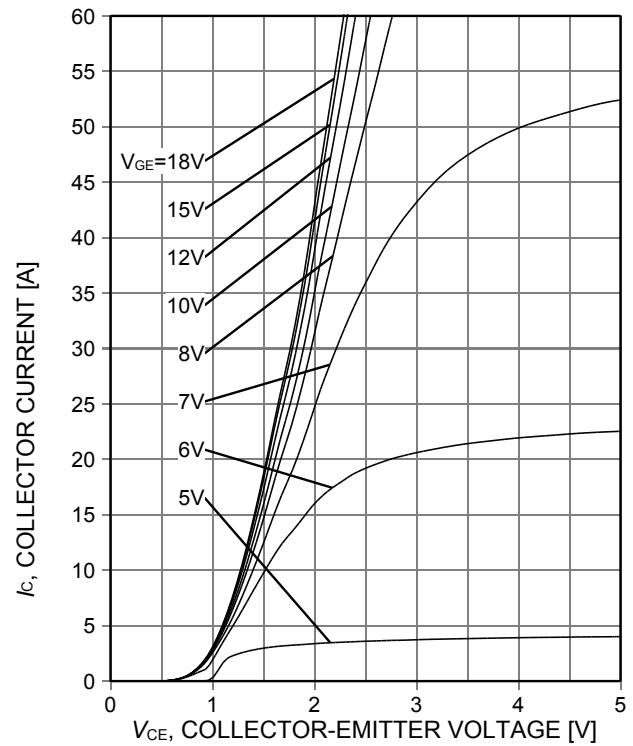


Figure 4. **Typical output characteristic**

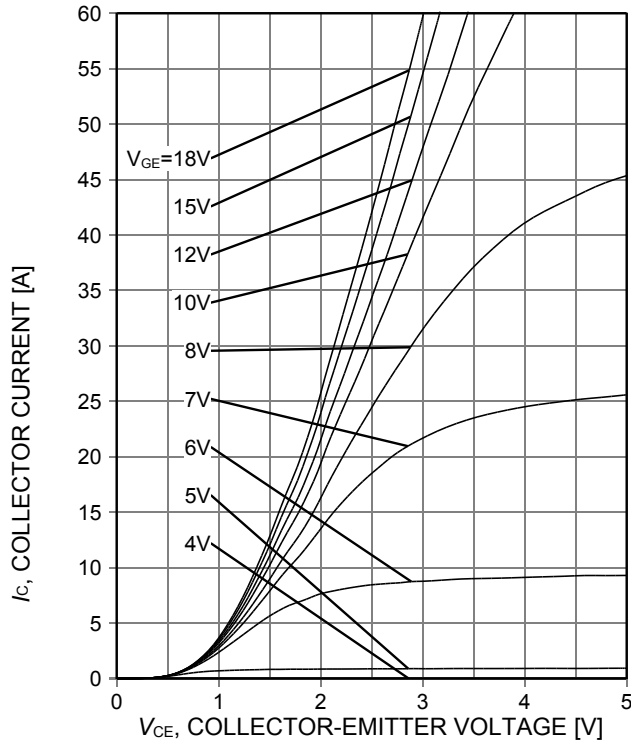


Figure 5. Typical output characteristic  
( $T_{vj}=150^{\circ}\text{C}$ )

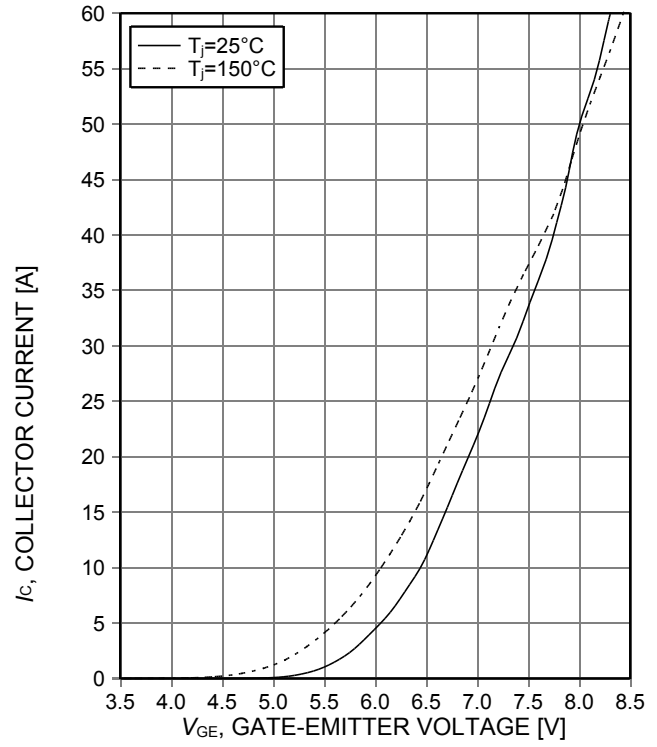


Figure 6. Typical transfer characteristic  
( $V_{ce}=20\text{V}$ )

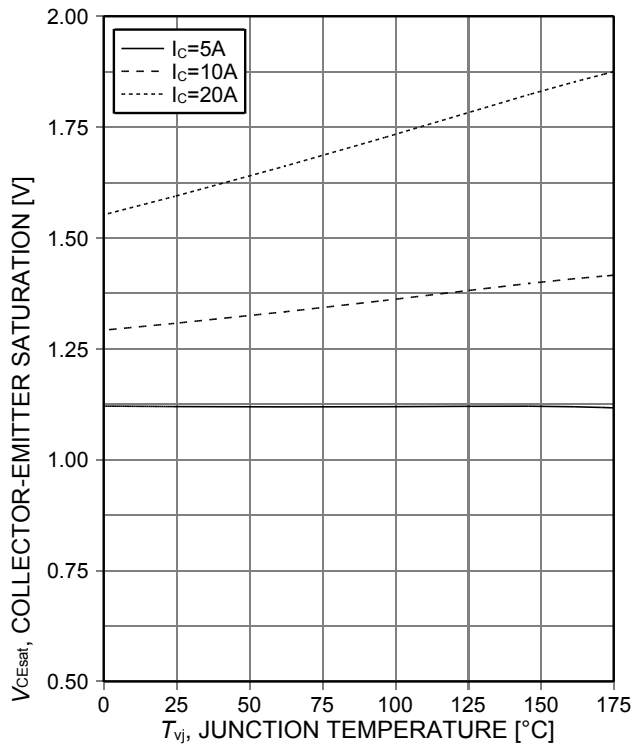


Figure 7. Typical collector-emitter saturation voltage as  
a function of junction temperature

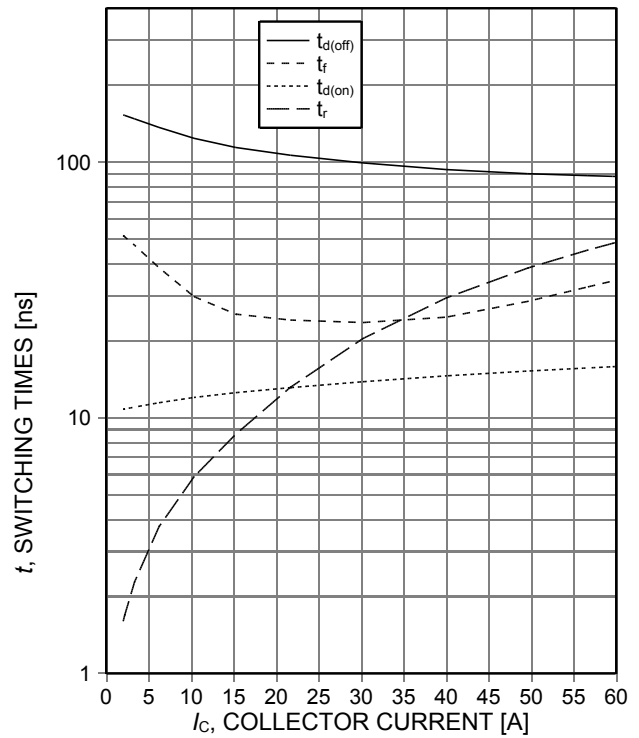


Figure 8. Typical switching times as a function of  
collector current

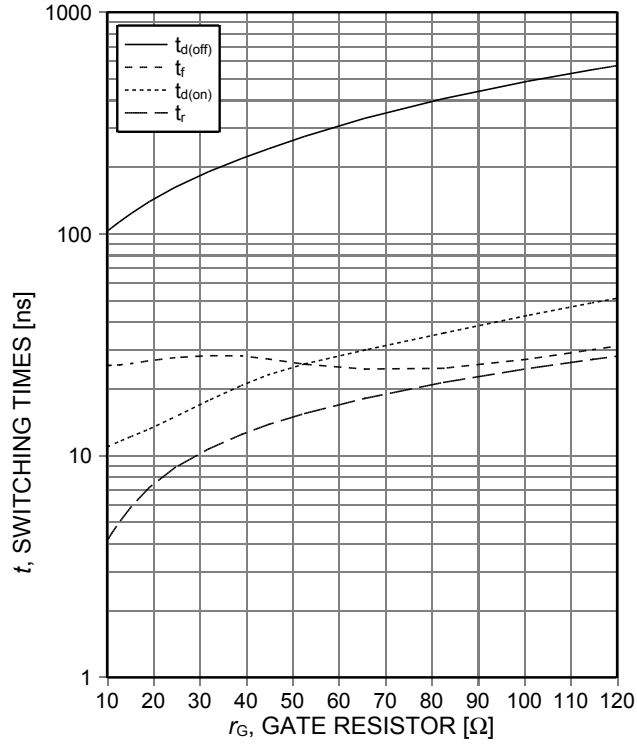


Figure 9. Typical switching times as a function of gate resistor

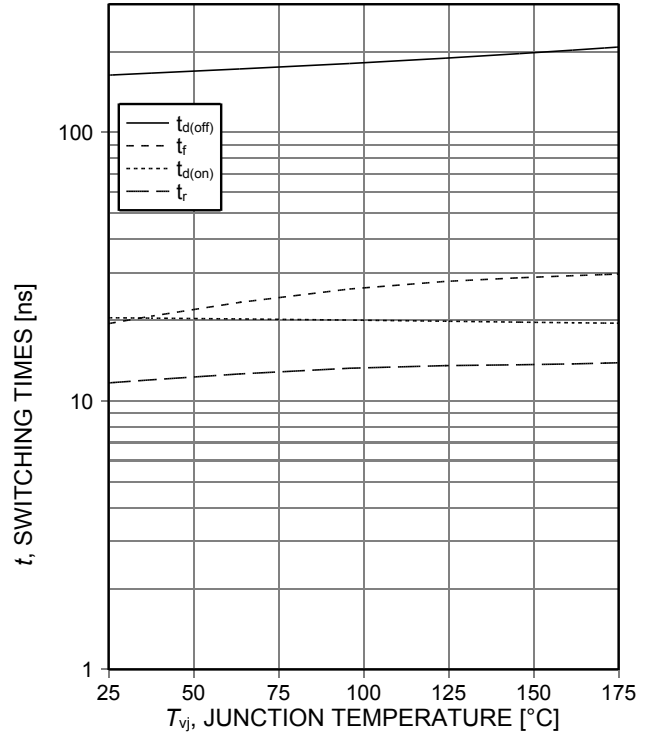


Figure 10. Typical switching times as a function of junction temperature

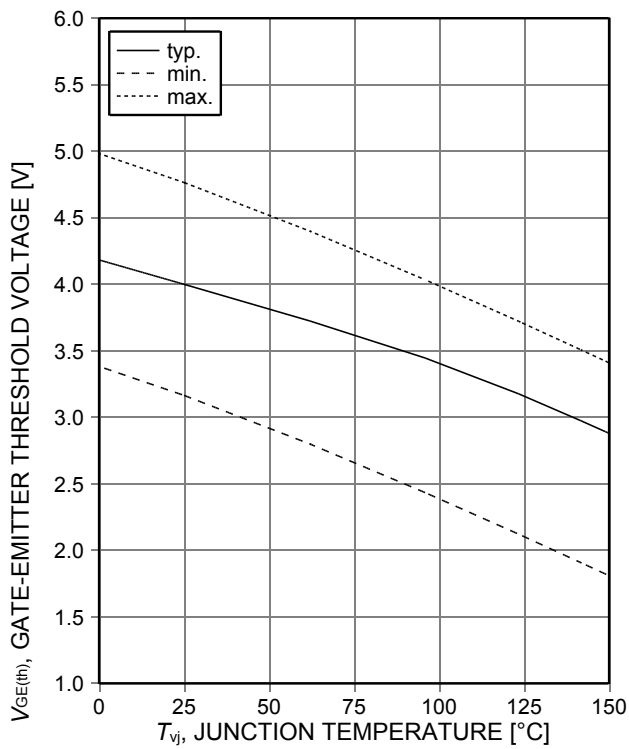


Figure 11. Gate-emitter threshold voltage as a function of junction temperature

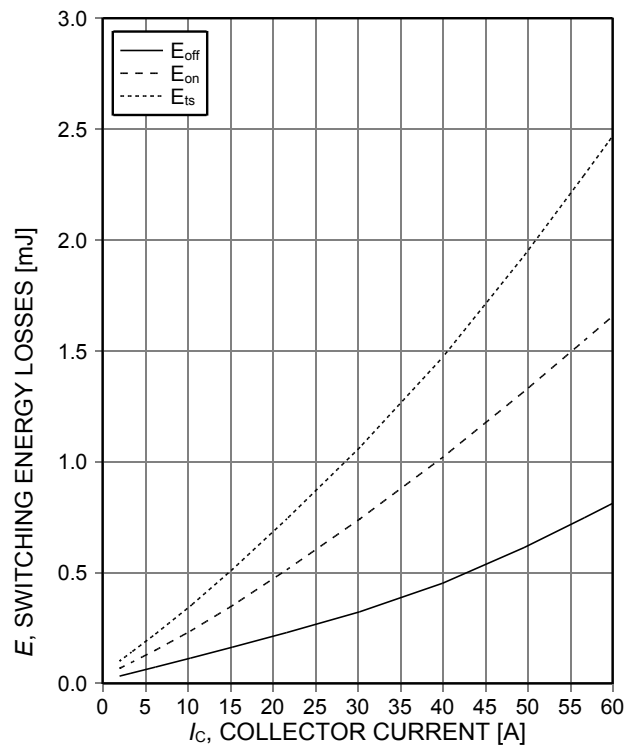


Figure 12. Typical switching energy losses as a function of collector current

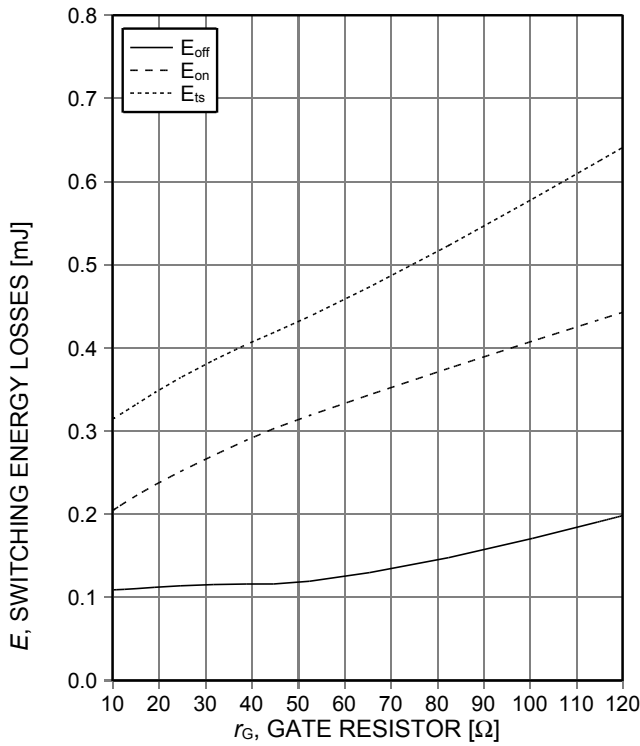


Figure 13. Typical switching energy losses as a function of gate resistor

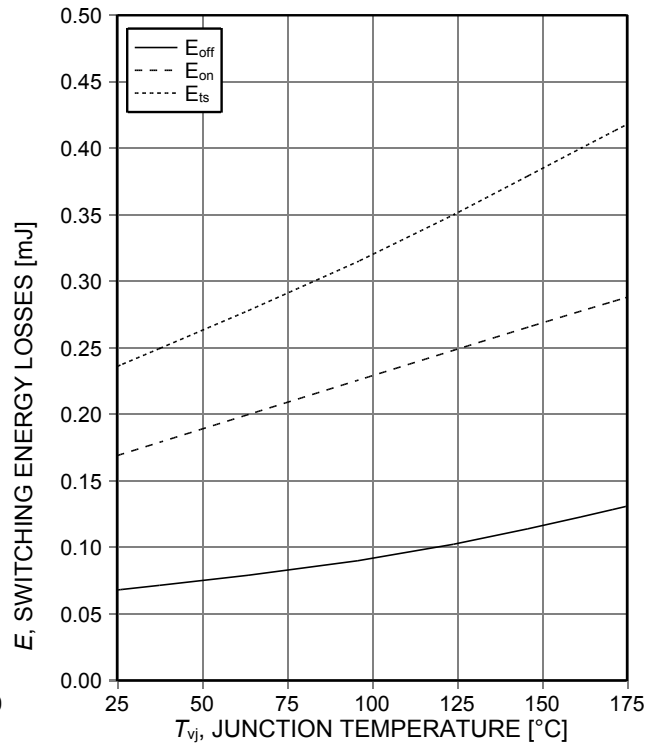


Figure 14. Typical switching energy losses as a function of junction temperature

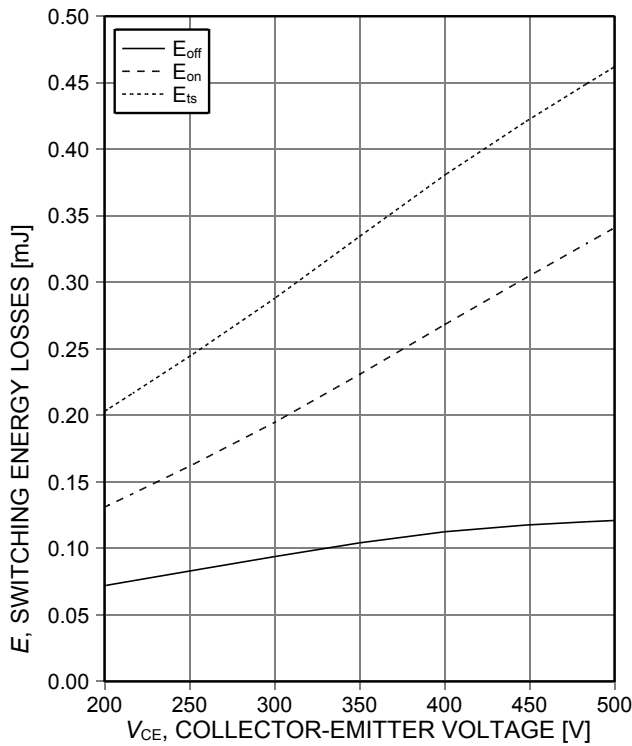


Figure 15. Typical switching energy losses as a function of collector emitter voltage

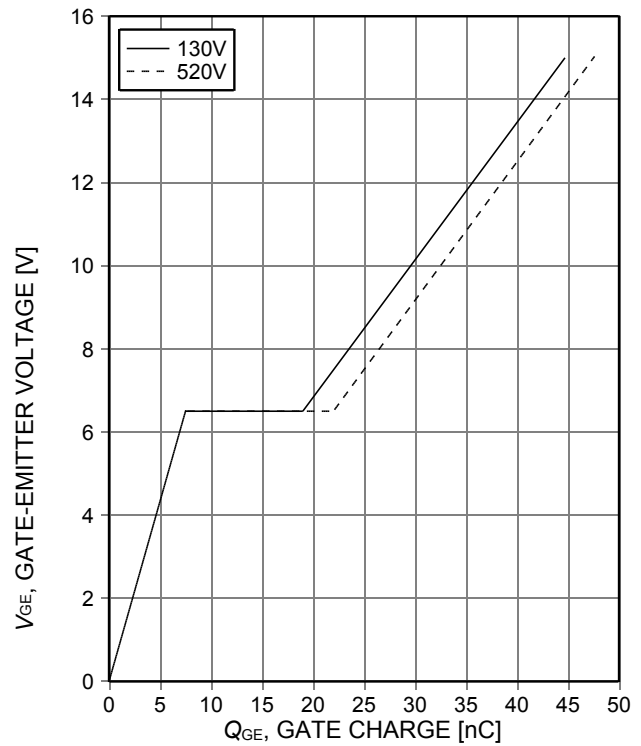


Figure 16. Typical gate charge

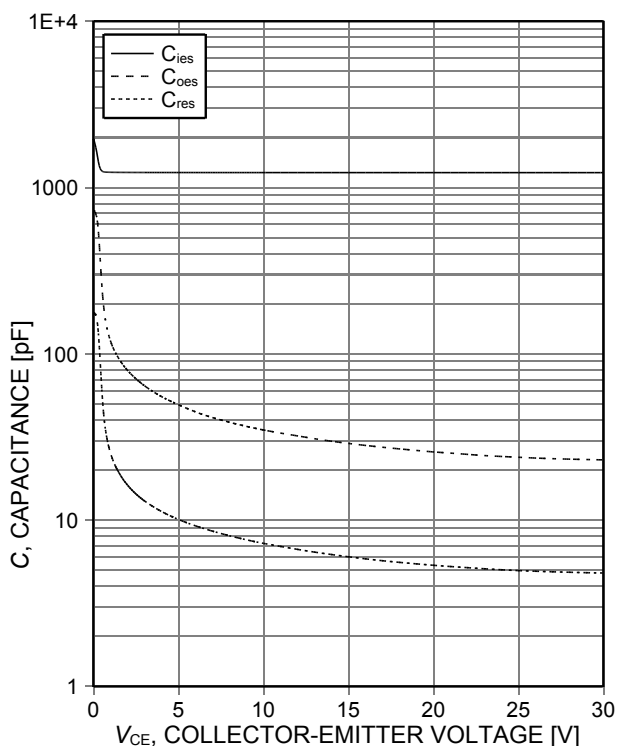


Figure 17. Typical capacitance as a function of collector-emitter voltage

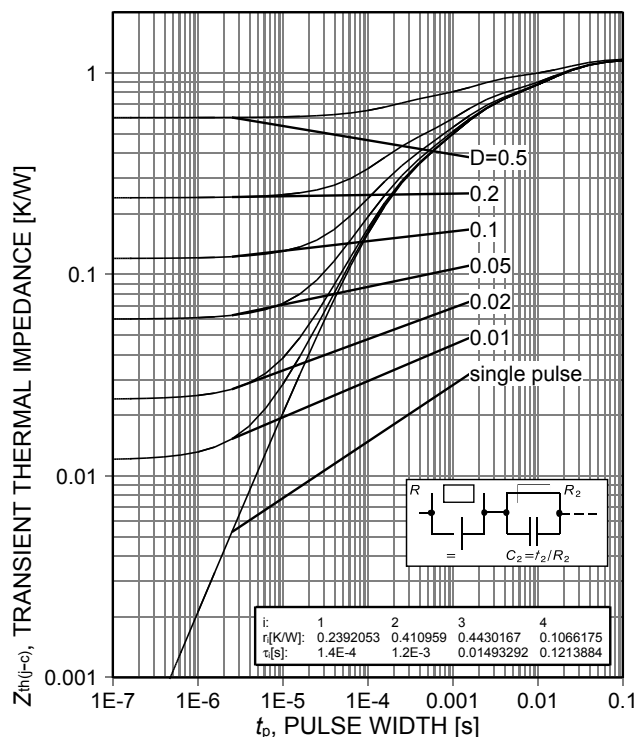


Figure 18. IGBT transient thermal impedance

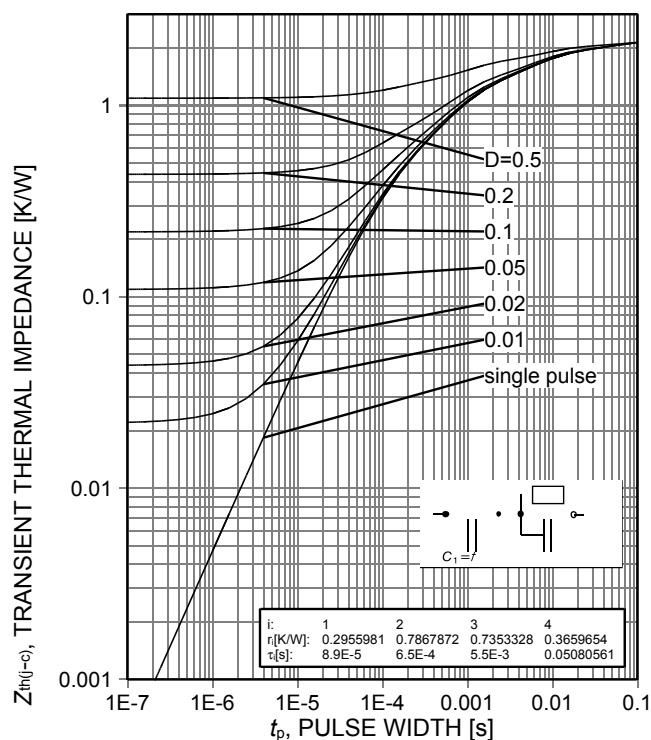


Figure 19. Diode transient thermal impedance as a function of pulse width

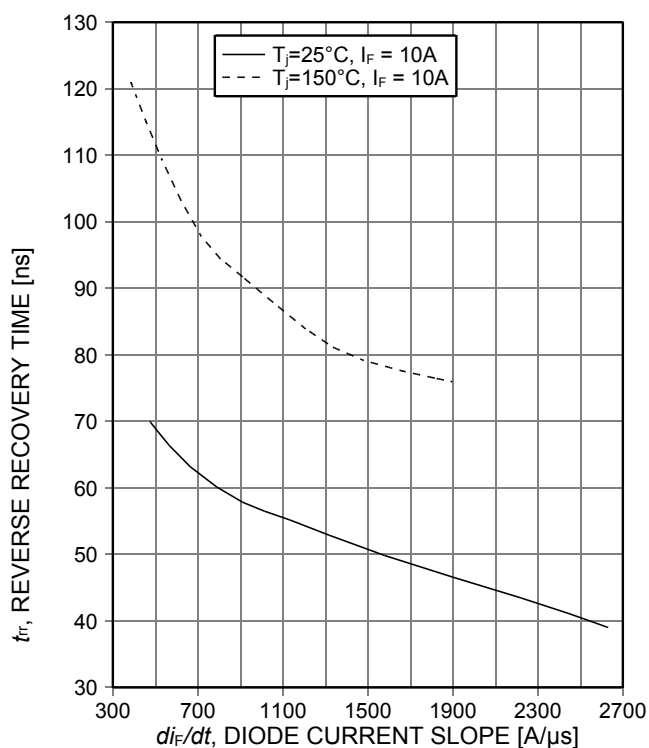
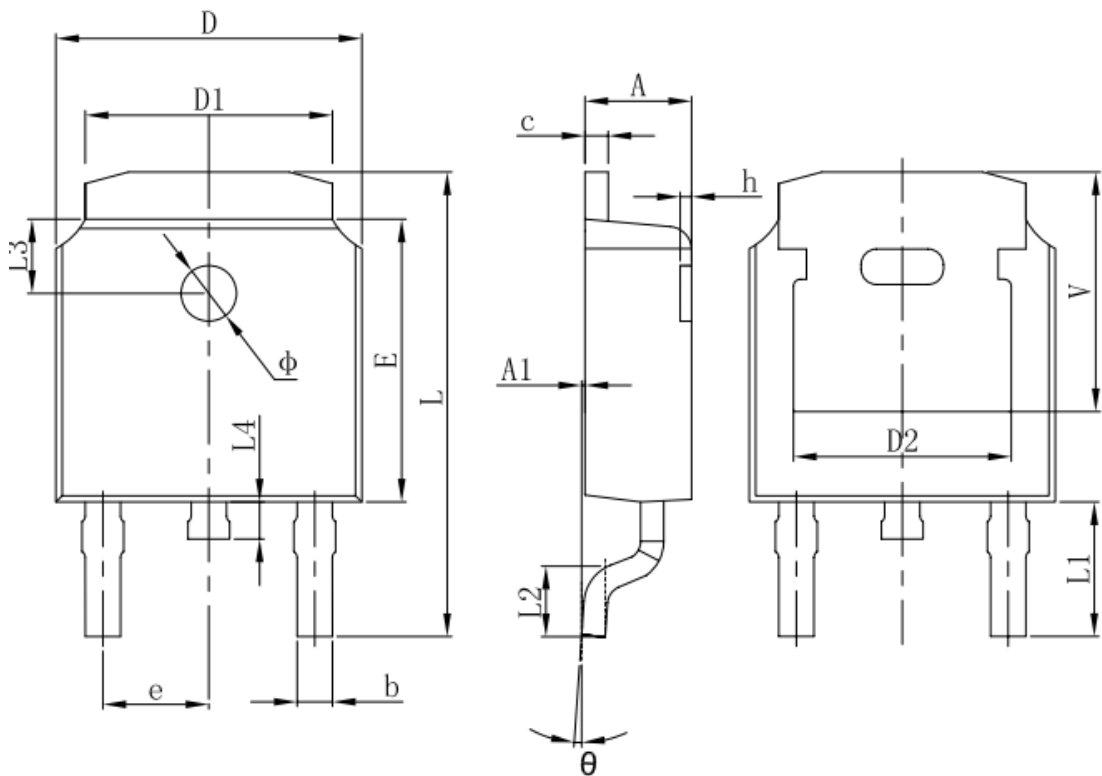


Figure 20. Typical reverse recovery time as a function of diode current slope

# TO252 Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.635                     | 0.770  | 0.025                | 0.030 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 REF.                |        | 0.190 REF.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.712                     | 10.312 | 0.382                | 0.406 |
| L1     | 2.900 REF.                |        | 0.114 REF.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 REF.                |        | 0.063 REF.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.250 REF.                |        | 0.207 REF.           |       |



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